

JOHNS HOPKINS

# Engineering Innovation

ei.jhu.edu



*"It gave me a general understanding of the numerous types of engineering. I have learned many useful skills and information that will help me in both my high school classes and when I go to college."*

--- Simon G. Engineering Innovation Student

*"It exposed me to the facets of engineering and what it means to be an engineer. It helped me realize precisely the field I like and what aspects of engineering are interesting to me."*

--- Leah B. Engineering Innovation Student



## BE A PART OF THE FUTURE OF ENGINEERING

Support talented and deserving high school students

Your contribution of \$2,850 provides tuition for one qualified and deserving student to attend the Johns Hopkins Engineering Innovation Summer Program at one of our commuter locations.

### Engineering Innovation provides:

- A four-week college engineering course for high school students.
- Hands-on engineering lab activities in chemical, electrical, mechanical, civil, structural, and materials engineering.
- College level engineering lectures.
- An opportunity for high school students to earn Johns Hopkins University engineering credits.

### Since 2006

- 4115 students have completed Engineering Innovation
- 37% have received financial support
- 94% reported that Engineering Innovation challenged them in ways they had not experienced before
- 95% reported that engineering would be a rewarding career



*"Engineering Innovation plays a major role in ensuring that students have an introduction to and an understanding of the education and opportunities they could pursue for success in the 21<sup>st</sup> century."*

-T.E. Schlesinger, Benjamin T. Rome Dean, Johns Hopkins Whiting School of Engineering



University of San Diego®  
**SHILEY-MARCOS**  
**SCHOOL OF ENGINEERING**



**JOHNS HOPKINS**  
WHITING SCHOOL  
of ENGINEERING

## SPONSORSHIP PLEDGE FORM

Company \_\_\_\_\_

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Contact Person \_\_\_\_\_ Telephone \_\_\_\_\_

**All Corporate sponsors will be recognized by:**

Corporate logo posted on the Engineering Innovation website

**Corporate sponsors pledging \$5,000 or more will be recognized by:**

Corporate logo on the Engineering Innovation student t-shirt

Invitation to meet with EI students during the course

Invitation to & VIP seating for the Spaghetti Bridge Ceremony and luncheon



**CHOOSE YOUR SUPPORT**

- We would like to contribute \$ 5,000 to *Engineering Innovation*.
- We would like to support \_\_\_\_\_ **Engineering Innovation Students** at \$2,850 each - Total pledge = \$ \_\_\_\_\_
- We would like to contribute \$ \_\_\_\_\_ to *Engineering Innovation*.  
(Contributions are 100% tax-deductible, to the extent allowable by law.)

**PAYMENT OPTIONS**

- Our sponsorship in the amount of \$ \_\_\_\_\_ is enclosed.  
(Please make your check payable to *Johns Hopkins University*.)
- Please bill the following credit card in the amount of \$ \_\_\_\_\_.  
Card #: \_\_\_\_\_ Expiration Date: \_\_\_\_\_  
Signature \_\_\_\_\_ Card Type (circle one): Visa    MasterCard    AmEx
- Our pledge of \_\_\_\_\_ will be sent by May 1, 2019.

**Please return pledge form to:**

*Engineering Innovation, Johns Hopkins University  
3400 N. Charles Street, Shaffer Hall 103  
Baltimore, MD 21218*



Authorized Signature \_\_\_\_\_ Date \_\_\_\_\_

**THANK YOU FOR SUPPORTING TOMORROW'S ENGINEERS**